L Numb r	Hits	Search Text	DB	Time stamp
304	2	westra.in. and silicon and anisotrop\$	USPAT;	2003/03/10
			US-PGPUB;	08:21
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
297	101	westra.in.	USPAT;	2003/03/10
			US-PGPUB;	08:21
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	2	("6008128").PN.	USPAT;	2002/09/17
			US-PGPUB;	09:09
}			EPO; JPO;	
			DERWENT;	
		·	IBM_TDB	
-	576	(359/223).CCLS.	USPAT;	2003/03/07
			US=PGPUB;	17:14
			EPO; JPO;	
			DERWENT;	
·			IBM_TDB	
	255	(359/298).CCLS.	USPAT;	2003/03/07
			US-PGPUB;	17:14
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	505	(359/838).CCLS.	USPAT;	2003/03/07
			US-PGPUB;	17:14
			EPO; JPO;	
			DERWENT;	
]			IBM_TDB	
-	88	(205/116).CCLS.	USPAT;	2003/03/07
			US-PGPUB;	17:15
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	135	((359/223).CCLS.) and silicon\$	USPAT;	2002/09/17
			US-PGPUB;	09:20
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	85	((359/298).CCLS.) and silicon\$	USPAT;	2002/09/17
			US-PGPUB;	10:21
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	66	((359/838).CCLS.) and silicon\$	USPAT;	2002/09/17
		·	US-PGPUB;	10:30
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

_	8	((205/116).CCLS.) and silicon\$	USPAT;	2002/09/17
			US-PGPUB;	10:33
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	421	silicon and mirror and bulk and monolith\$ and	USPAT;	2002/09/17
		crystal\$4	US-PGPUB;	10:43
		Ci y Si di W	EPO; JPO;	10.10
			DERWENT;	
			IBM_TDB	
_	46	(silicon and mirror and bulk and monolith\$ and	USPAT;	2002/09/17
	70	crystal\$4) and inlet and outlet	US-PGPUB;	10:37
		crystalp+) and inlet and outlet	EPO; JPO;	10.57
			DERWENT;	
			L .	
	34	military and patence and built and many list &	IBM_TDB	2002/00/47
-	31	silicon and mirror and bulk and monolith\$ and	USPAT;	2002/09/17
•		(crystal\$4 adj plane)	US-PGPUB;	10:51
			EPO; JPO;	
			DERWENT;	
			IBW_TDB	
-	89	(single adj crystal adj silicon) and mirror and	USPAT;	2002/09/17
		(crystal\$4 adj plane)	US-PGPUB;	11:08
			EPO; JPO;	
			DERWENT;	
			IBW_LDB	
-	692	(single adj crystal adj silicon) and mirror and plane	USPAT;	2002/09/17
		and etch\$3	US-PGPUB;	11:43
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	309	((single adj crystal adj silicon) and mirror and plane	USPAT;	2002/09/17
		and etch\$3) and anisotrop\$	US-PGPUB;	11:09
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	101	(((single adj crystal adj silicon) and mirror and plane	USPAT;	2002/09/17 11:10
		and etch\$3) and anisotrop\$) and fiber and optic\$4	US-PGPUB;	
		, , ,	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	121	(single and crystal and silicon) and mirror and plane	USPAT;	2002/09/17 14:11
	_	and etch\$3 and anisotrop\$ and fiber and optic\$4 and	US-PGPUB;	
		internal\$2	EPO; JPO;	
		······································	DERWENT;	
	i		IBM_TDB	
_	256	single and crystal\$4 and silicon and mirror and	USPAT;	2002/09/17
		etch\$3 and stripe and intersect\$4	US-PGPUB;	14:25
		orengo and on you and intersection	EPO; JPO;	47.60
			DERWENT;	
			IBM_TDB	
	I		+D/V_1UD	į l

	7		T	T
-	118	(singl and crystal\$4 and silicon and mirror and	USPAT;	2002/09/17
		etch\$3 and strip and intersect\$4) and internal	US-PGPUB;	11:58
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	373	(single near crystal\$4 near silicon) with mirror	USPAT;	2002/09/17
			US-PGPUB;	12:05
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	39	((single near crystal\$4 near silicon) with mirror) and	USPAT;	2002/09/17
		(fiber near optic\$4)	US-PGPUB;	12:06
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	3645	digital and mirror and device and silicon and	USPAT;	2002/09/17
		crystal\$4	US-PGPUB;	14:12
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	168	(digital and mirror and device and silicon and	USPAT;	2002/09/17
	100	crystal\$4) and bulk and monolith\$	US-PGPUB;	14:12
		crystale ty and balk and monorthy	EPO; JPO;	1 1112
			DERWENT;	
		•	IBM_TDB	
_	341	silicon and mirror and etch\$3 and stripe and	USPAT;	2002/09/17
-	341	intersect\$4	US-PGPUB;	14:36
		mersecry	EPO; JPO;	14.30
			DERWENT;	
	2259	 	IBM_TDB	2002 (00 /17
_	2209	silicon and mirror and pattern\$3 and anisotrop\$	USPAT;	2002/09/17
			US-PGPUB;	14:37
			EPO; JPO;	
			DERWENT;	
	400	Cathalla add amarkalded 10 add No. 4 and 1	IBM_TDB	2002/00/47
-	403	(single adj crystal\$4 adj silicon) and mirror and	USPAT;	2002/09/17
		pattern\$3 and anisotrop\$	US-PGPUB;	15:20
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	0	(bulk with (single adj crystal\$4 adj silicon)) and	USPAT;	2002/09/17
]	(mirror near pattern\$3)	US-PGPUB;	15:22
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	20	silicon and (mirror near pattern\$3) and (anisotrop\$	USPAT;	2002/09/17
	1	near etch\$3)	US-PGPUB;	15:34
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

	1/	silian and (/minnen nann nattaur. \$2)ith annu	USPAT;	2002/09/17
-	16	silicon and ((mirror near pattern\$3) with array\$)	USPAT; US-PGPUB;	15:39
			1	10.07
			EPO; JPO; DERWENT;	
			1	
	2505	Continuo mitale anno del moderni del com	IBM_TDB	2002/00/47
-	2585	(mirror with array\$) and silicon	USPAT;	2002/09/17
			US-PGPUB;	16:16
			EPO; JPO;	
			DERWENT;	
		A 171 H 11 11 11	IBM_TDB	2002/00/47
-	9	(mirror with array\$) and (bulk with single with	USPAT;	2002/09/17
		crystal\$4 with silicon)	US-PGPUB;	15:43
			EPO; JPO;	
			DERWENT;	
	_		IBM_TDB	2002/22 #=
-	2	((mirror with array\$) and silicon) and anisotrop\$ and	USPAT;	2002/09/17
		(bulk near crystal\$4)	US-PGPUB;	15:44
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0000 400 477
-	2	monolithic adj bulk adj crystal adj silicon	USPAT;	2002/09/17
			US-PGPUB;	16:17
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	2	monolithic with bulk with crystal with silicon	USPAT;	2002/09/17
			US-PGPUB;	16:17
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0000/00 //=
-	1586	monolithic and bulk and crystal and silicon	USPAT;	2002/09/17
			US-PGPUB;	16:18
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	000040047
-	25	(monolithic and bulk and crystal and silicon) and	USPAT;	2002/09/17
		(crystalline near plane)	US-PGPUB;	16:19
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	000040045
-	362	(monolithic and bulk and crystal and silicon) and	USPAT;	2002/09/17
		(crystalline and plane)	US-PGPUB;	16:20
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	2000/22 //=
-	4	((monolithic and bulk and crystal and silicon) and	USPAT;	2002/09/17
		(crystalline and plane)) and (micro?mirror or (micro	US-PGPUB;	16:20
		adj mirror))	EPO; JPO;	
			DERWENT;	
			IBM_TDB	

	100	W. Bills II B. L. and Lette North	LICDAT.	2002/00/17
-	109	((monolithic and bulk and crystal and silicon) and	USPAT;	2002/09/17
		(crystallin and plane)) and mirror	US-PGPUB;	16:41
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	4	silicon near mirror n ar array	USPAT;	2002/09/17
			US-PGPUB;	16:42
			EPO; JPO;	
		,	DERWENT;	
			IBM_TDB	
-	1415	digital near (micromirror or micro?mirror or (micro	USPAT;	2002/09/17
		adj mirror)) near device	US-PGPUB;	16:43
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	350	(digital near (micromirror or micro?mirror or (micro	USPAT;	2002/09/17
		adj mirror)) near device) and silicon	US-PGPUB;	17:12
			EPO; JPO;	
1			DERWENT;	
			IBM_TDB	
_	16	(digital near (micromirror or micro?mirror or (micro	USPAT;	2002/09/17
		adj mirror)) near device) and (single adj crystal adj	US-PGPUB;	17:14
		silicon)	EPO; JPO;	
		333)	DERWENT;	
			IBM_TDB	
_	3991	(mirror or reflect\$) and (single adj crystal adj	USPAT;	2002/09/17
	3771	silicon)	US-PGPUB;	17:16
		Sincony	EPO; JPO;	17.10
			DERWENT;	
			IBM_TDB	
	240	((mirror or reflect\$) and (single adj crystal adj	USPAT;	2002/09/17
_	240	silicon)) and bulk and monolith\$	US-PGPUB;	17:42
		Silicon)) and bulk and monolithy	EPO; JPO;	17.42
			DERWENT;	
	140	anigaturant with allians with annus with at the	IBM_TDB	2002/00/17
-	148	anisotrop\$ with silicon with array with etch\$4	USPAT;	2002/09/17
			US-PGPUB;	17:43
			EPO; JPO;	
			DERWENT;	
	224	Contract the state of the state	IBM_TDB	2002/00/47
-	226	(anisotrop\$ with silicon with process\$) and (mirror or	USPAT;	2002/09/17
		reflector)	US-PGPUB;	18:38
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	25	silicon and mirror and passage and (crystalline adj	USPAT;	2002/09/17
		plane)	US-PGPUB;	18:42
			EPO; JPO;	
ļ			DERWENT;	
			IBM_TDB	

<u> </u>	42	(monolithic and bulk and crystal and silicon) and	USPAT;	2002/09/17
	'-	(mirror or reflector) and crystalline and plan and	US-PGPUB;	18:44
		intersect\$4	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	606	(359/223). <i>CC</i> LS.	USPAT;	2003/03/07
		(00)/1220).0020.	US-PGPUB;	17:15
			EPO; JPO;	17.13
			DERWENT;	
	0		IBM_TDB	
	290	(359/298).CCLS.	USPAT;	2003/03/07
-		(33), 270).0023.	US-PGPUB;	17:28
			EPO; JPO;	17.20
			DERWENT;	
			IBM_TDB	
	553	(359/838).CCL5.	USPAT;	2003/03/07
] -	333	(3397030).0023.	US-PGPUB;	17:27
			EPO; JPO;	17.27
	<u> </u>		DERWENT;	
			IBM_TDB	
	88	(205/116). <i>CC</i> LS.	USPAT;	2003/03/07
		(203/110).0023.	US-PGPUB;	17:27
			EPO; JPO;	17.27
			DERWENT;	
			IBM_TDB	
_	42	((359/223).CCLS.) and (mirror or reflector) and	USPAT;	2003/03/07
	,-	anisotrop\$	US-PGPUB;	17:28
		amson opp	EPO; JPO;	1,120
			DERWENT;	
İ			IBM_TDB	
_	23	((359/298).CCLS.) and (mirror or reflector) and	USPAT;	2003/03/07
		anisotrop\$	US-PGPUB;	17:52
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	15	((359/838).CCLS.) and (mirror or reflector) and	USPAT;	2003/03/07
		anisotrop\$	US-PGPUB;	17:54
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	1	((205/116).CCLS.) and (mirror or reflector) and	USPAT;	2003/03/07
		anisotrop\$	US-PGPUB;	17:56
			EPO; JPO;	-,
			DERWENT;	
			IBM_TDB	
_	244	silicon and ((mirror or reflector) with anisotrop\$)	USPAT;	2003/03/10
		Σ. Σ	US-PGPUB;	08:20
			EPO; JPO;	
		•	DERWENT;	
			IBM_TDB	
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